

$PIC16C71 \rightarrow PIC16C710/711$ Migration

DEVICE MIGRATIONS

This document is intended to describe the functional differences and the electrical specification differences that are present when migrating from one device to the next.

Note: This device has been designed to perform to the parameters of its data sheet. It has been tested to an electrical specification designed to determine its conformance with these parameters. Due to process differences in the manufacture of this device, this device may have different performance characteristics than its earlier version. These differences may cause this device to perform differently in your application than the earlier version of this device.

Table 1 shows the considerations that must be taken into account when migrating from the PIC16C71 to the PIC16C710/711.

TABLE 1: PIC16C71 \rightarrow PIC16C710/711 DIFFERENCES

Functio	Functional Differences											
No.	Difference	H/W	S/W	Prog.								
1	Programming algorithm change			~								
2	PIC16C710/711 has BOR circuit	~		~								

Note: The user should verify that the device oscillator starts and performs as expected. Adjusting the loading capacitor values and /or the oscillator mode may be required.

TABLE 2: PROGRAM AND DATA MEMORY DIFFERENCES

	PIC16C71	PIC16C710	PIC16C711
Program Memory	1024	512	1024
Data Memory	36	36	68

Parm.	Sym.		PIC16C7	71 Data S	heet	PIC16C710	/711 Data	Units		
No.	Sym.	Characteristic	Min	Тур	Max	Min Typ			Max	Conditions
Vdd		Supply Voltage XT, RC, LP Options XT, RC Opt. Extended	3.0		6.0	2.5 3.0		6.0 6.0	V V	LC versions LC version
	Idd	Supply Current								PIC16C71/710
		XT and RC options HS option	_	1.8 4.8	3.3 10		1.8 4.5	2.4 16	mA mA	711 Note 1 Note 2 PIC16LC71/ 710/711
		XT and RC options LP option	_	1.4 15	2.5 32	_	2.0 22.5	3.8 48	mA μA	Note 3 Note 4
	IPD	Power Down Current							per 2	PIC16C71/710
		Commercial Industrial Extended		1.0 7 1.0 —	14 28.0 16 —		1.5 10.5 1.5 1.5	21 41 24 30	μΑ μΑ μΑ μΑ	711 VDD = 4.0 WDT Disabled WDT enabled WDT disabled PIC16LC71/ 710/711
		Commercial Industrial		0.6 5 0.6	9.0 20 12		0.9 7.5 0.9	5 30 5.0	μΑ	VDD = 3.0 WDT disabled WDT enabled WDT disabled
	N faire	Extended			—	—	0.9	10		WDT disabled
	Vih	Input High Voltage I/O Ports with Schmitt Trigger buffer MCLR, RB0/INT	0.85Vdd 0.85Vdd		Vdd Vdd	0.8Vdd 0.8Vdd		Vdd Vdd	V V	For all VDD
	Fosc	Oscillator Frequency	4					20		
			1 1 DC	-	4 20 200	4 5		20 — 200	MHz MHz kHz	HS osc mode HS osc mode LP osc mode
	TmLC	MCLR Pulse Width (low)	0.2	-	_	2	_	_	μs	Note 5
	Tloz	I/O HIgh Impedance from MCLR Low	_	_	0.1	_	_	1.1	μs	
	Eabs	Absolute Error (AD converter)	_	_	<±2	_	_	< ±1	LSb	LC versions
	EIL	Integral linearity error (AD converter)	_	_	<±2	_	_	< ±1	LSb	LC versions
	Edl	Differential linearity error (AD converter)			<±2	_	_	< ±1	LSb	LC versions
	Efs	Full Scale Error (AD converter)	_		<±2	_	_	< ±1	LSb	LC versions
	EOFF	Offset Error (AD converter)	_		<±2	_	_	< ±1	LSb	LC versions

TABLE 3:	ELECTRICAL	SPECIFICATION	DIFFERENCES

Note 1: Fosc = 4.0MHz, VDD = 5.5V.

2: Fosc = 20MHz, VDD = 5.5V.

3: Fosc = 4MHz, VDD = 3.0V.

4: Fosc = 32kHz, VDD = 3.0V, WDT disabled.

5: For PIC16C71: VDD = 5.0V, -40°C to +85°C; For PIC16C710/711: VDD = 5.0V, -40°C to +125°C.

Description	PIC16C71 Data Sheet	PIC16C710/711 Data Sheet	Units
Total Power Dissipation	0.8	1	W
Maximum Current out of Vss Pin	150	300	mA
Maximum Current into VDD Pin	100	250	mA
Maximum Current Sourced by any I/O Pin	20	25	mA
Maximum Current Sunk by PORTA	80	200	mA
Maximum Current Sourced by PORTA	50	200	mA
Maximum Current Sunk by PORTB	150	200	mA
Maximum Current Sourced by PORTB	100	200	mA

FIGURE 1: CONFIGURATION WORD FOR PIC16C71

— · bit13		_	_	_	_	_	_	CP0	PWRTE	WDTE	FOSC1	FOSC0 bit0	Register: Address	CONFIG 2007h
bit 13-5:	Unimplen	nented	: Read	as '1'										
bit 4:	CP0: Cod 1 = Code 0 = All me	protecti	on off		ed, but	00h - 3	Fh is w	vritable						
bit 3:	PWRTE: I 1 = Power 0 = Power	-up Tim	ner ena	bled	le bit									
bit 2:	WDTE: W 1 = WDT e 0 = WDT e	enabled	Ī	r Enable	e bit									
bit 1-0:	FOSC<1:0 11 = RC c 10 = HS c 01 = XT o 00 = LP o	oscillato oscillato scillato	r r r	Selectic	on bits									

FIGURE 2: CONFIGURATION WORD FOR PIC16C710/711

CP0 (CP0 C	P0 CP0	CP0	CP0	CP0	BODEN	CP0	CP0	PWRTE	WDTE	FOSC1	FOSC0	Register:	CONFIG
bit13												bit0	Address	2007h
bit 13-7 5-4: bit 6:	1 = Co 0 = Al BODE 1 = BO	Code Pro de protec memory N: Browr)R enable	ction off is code i-out Re ed	protec			8Fh is w	vritable						
bit 3:	PWR 1 = P\	OR disable E: Power VRT disat VRT enat	-up Tim bled	ner Ena	able bit	(1)								
bit 2:	1 = W	: Watchd DT enabl DT disabl	əd	er Enat	ole bit									
bit 1-0:	11 = F 10 = F 01 = >	<1:0>: O C oscilla S oscilla T oscillat P oscillat	tor tor tor	Select	ion bit	S								
	Ensur	e the Pow	/er-up T	imer is	enabl	ed any ti	me Bro	wn-out	Reset is	enable	ed.	ess of the scheme li	e value of bit i	PWRTE.

Note: The Power-up Timer enable bit has a reverse polarity on the PIC16C71 and PIC16C710/711.

TABLE 5:	TAD VS. DEVICE OPERATING FREQUENCIES, PIC16C71
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AD Cloc	k Source (TAD)		y			
Operation	ADCS<1:0>	20 MHz	16 MHz	4 MHz	1 MHz	333.33 kHz
2Tosc	0.0	100 ns ⁽²⁾	125 ns ⁽²⁾	500 ns ⁽²⁾	2.0 μs	6 μs
8Tosc	01	400 ns ⁽²⁾	500 ns ⁽²⁾	2.0 μs	8.0 μs	24 μs (3)
32Tosc	10	1.6 μs (2)	2.0 μs	8.0 μs	32.0 μs ⁽³⁾	96 μs ⁽³⁾
RC ⁽⁵⁾	11	2 - 6 μs ^(1,4)	2 - 6 μs ^(1,4)	2 - 6 μs ^(1,4)	2 - 6 μs ⁽¹⁾	2 - 6 μs ⁽¹⁾

Legend: Shaded cells are outside of recommended range.

Note 1: The RC source has a typical TAD time of 4 μ s.

- 2: These values violate the minimum required TAD time.
- 3: For faster conversion times, the selection of another clock source is recommended.

4: When device frequency is greater than 1 MHz, the RC A/D conversion clock source is recommended for SLEEP operation only.

5: For extended voltage devices (LC), please refer to Electrical Specifications section.

TABLE 6: TAD vs. DEVICE OPERATING FREQUENCIES, PIC16C710/711

AD Clock	Source (TAD)	Device Frequency						
Operation	ADCS<1:0>	20 MHz	5 MHz	1.25 MHz	333.33 kHz			
2Tosc	00	100 ns ⁽²⁾	400 ns ⁽²⁾	1.6 μs	6 µs			
8Tosc	01	400 ns ⁽²⁾	1.6 μs	6.4 μs	24 μs ⁽³⁾			
32Tosc	10	1.6 μs	6.4 μs	25.6 μs ⁽³⁾	96 μs ⁽³⁾			
RC ⁽⁵⁾	11	2 - 6 μs ^(1,4)	2 - 6 μs ^(1,4)	2 - 6 μs ^(1,4)	2 - 6 μs ⁽¹⁾			

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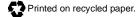
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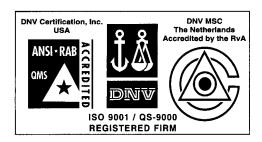
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